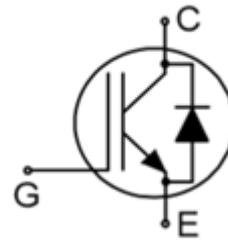


Trench Field-Stop Technology IGBT

Features

- 1200V, 40A
- $V_{CE(sat)(typ.)} = 2.25V @ V_{GE} = 15V, I_C = 40A$
- Low Switching Losses
- $V_{CE(sat)}$ with Positive Temperature Coefficient
- Pb-free Lead Plating; RoHS Compliant



Applications

- Uninterrupted Power Supply
- Motor Drives

Order codes	V_{CE}	I_C	$V_{CEsat}, T_{vj}=25^{\circ}C$	T_{vjmax}	Marking	Package
XD040H120AT2S3	1200V	40A	2.25V	150°C	D40H120AT2	TO247-3

Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	±20	V
I_C	Continuous Collector Current ($T_C=25^{\circ}C$)	40	A
	Continuous Collector Current ($T_C=100^{\circ}C$)	20	A
I_{CRM}	Repetitive peak collector current	80	A
I_F	Diode Continuous Forward Current ($T_C=25^{\circ}C$)	40	A
	Diode Continuous Forward Current ($T_C=100^{\circ}C$)	20	A
I_{FM}	Diode Maximum Forward Current (Note 1)	80	A
R_{Gint}	Internal Gate Resistor	3.5	Ω
t_{sc}	Short Circuit Withstand Time	10	us
P_{tot}	Total Power Dissipation ($T_C=25^{\circ}C$)	577	W
T_J	Operating Junction Temperature Range	-40 to 175	°C
T_{STG}	Storage Temperature Range	-40 to 125	°C

Thermal Data

Symbol	Parameter	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case for IGBT	0.26	°C/W

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{CES}	Collector-Emitter Breakdown Voltage	$V_{GE}=0V, I_C=500\mu A$	1200	---	---	V
I_{CES}	Collector-Emitter Leakage Current	$V_{CE}=1200V, V_{GE}=0V$	---	---	1	mA
I_{GES}	Gate Leakage Current, Forward	$V_{GE}=20V, V_{CE}=0V$	---	---	450	nA
	Gate Leakage Current, Reverse	$V_{GE}=-20V, V_{CE}=0V$	---	---	-450	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE}=V_{CE}, I_C=1mA$	6.1	6.6	7.3	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=40A$	---	2.25	---	V
Q_G	Total Gate Charge	$V_{GE}=15V$	---	285	---	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600V$ $V_{GE}=\pm 15V$ $I_C=40A$ $R_G=4.7\Omega$ Inductive Load $T_C=25^\circ\text{C}$	---	73	---	ns
t_r	Turn-on Rise Time		---	175	---	ns
$t_{d(off)}$	Turn-off Delay Time		---	53.5	---	ns
t_f	Turn-off Fall Time		---	113.5	---	ns
E_{on}	Turn-on Switching Loss		---	4.82	---	mJ
E_{off}	Turn-off Switching Loss		---	1.85	---	mJ
E_{ts}	Total Switching Loss		---	4.00	---	mJ
C_{ies}	Input Capacitance	$V_{CE}=25V$	---	2.7	---	nF
C_{oes}	Output Capacitance	$V_{GE}=0V$	---	0.18	---	nF
C_{res}	Reverse Transfer Capacitance	$f=1MHz$	---	0.12	---	nF
I_{SC}	SC data	$V_{GE}\leq 15V, V_{CC}=800V$ $V_{CEmax}=V_{CES}-L_{sCE} \cdot di/dt$ $T_p\leq 10\mu S$	---	108	---	A

Diode Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=40A$	---	1.84	---	V
I_{RM}	Peak reverse recovery current	$V_R=600V$	---	17.6	---	A
Q_r	Recovered charge	$I_F=40A$	---	3.7	---	μC
E_{rec}	Reverse recovery energy	$V_{GE}=-15V$	---	1.37	---	mJ

Typical Characteristics

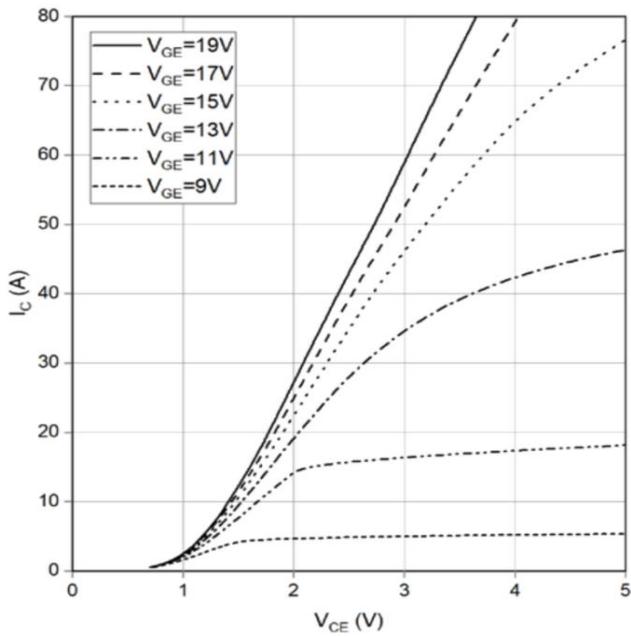


Fig. 1 Typical IGBT Output Characteristics at $T_J=150^\circ\text{C}$

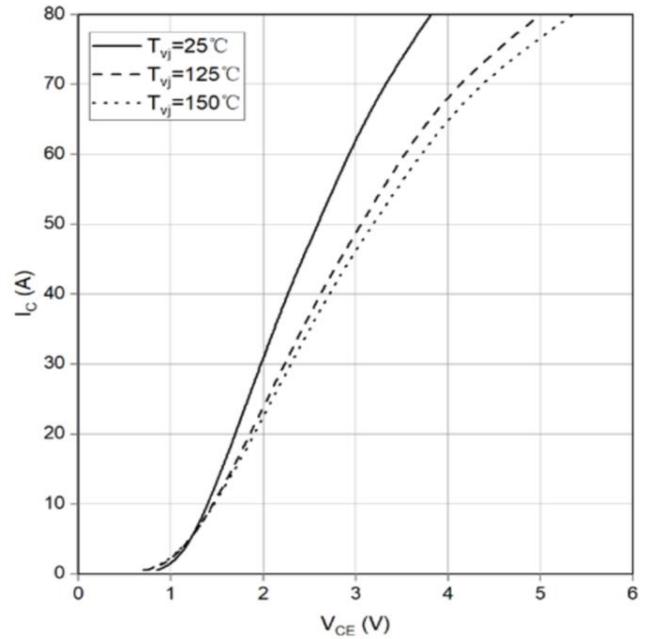


Fig. 2 Typical Transfer Characteristics at $V_{GE}=15\text{V}$

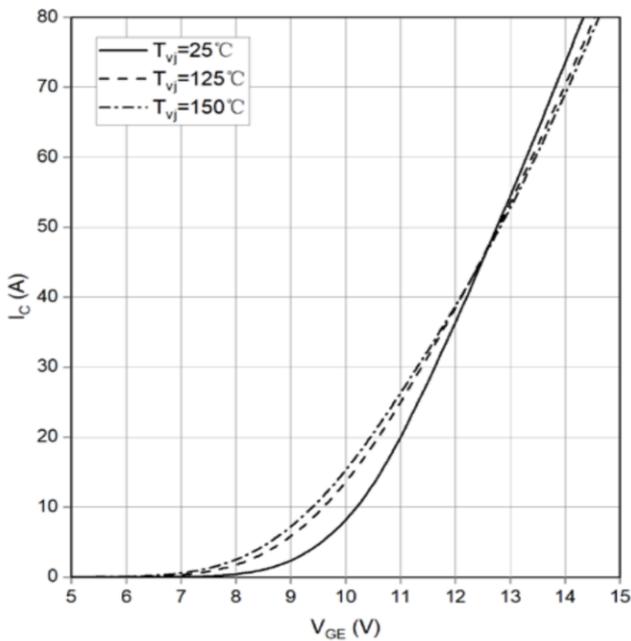


Fig. 3 Typical Transfer Characteristics at $V_{CE}=15\text{V}$

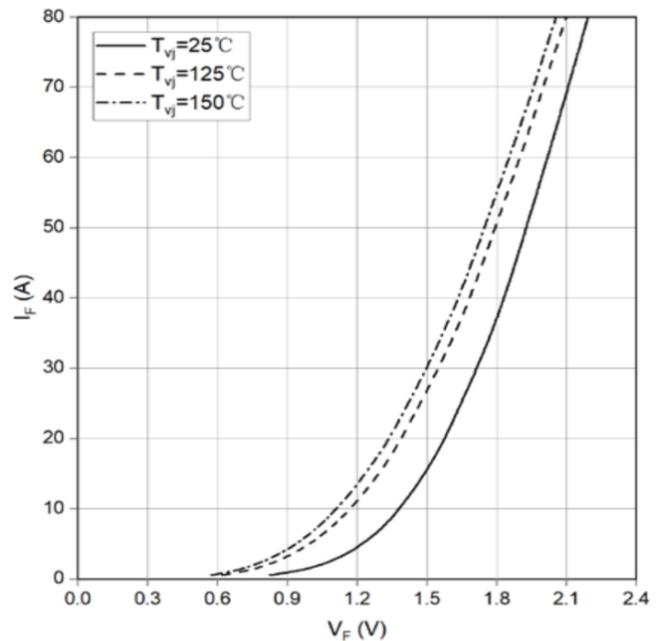


Fig. 4 Forward characteristic of Diode-Inverter

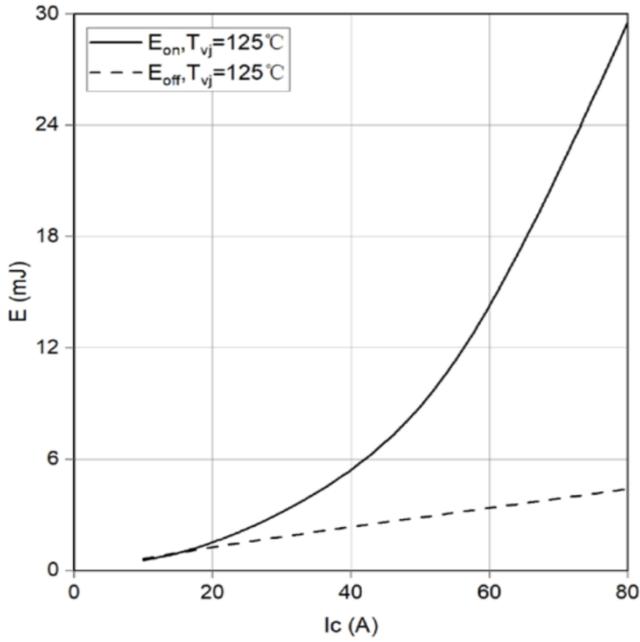


Fig. 5 Typical Energy Loss vs. Ic at T_C=25°C,
V_{CE}=600V, V_{GE}=15V, R_g=4.7Ω

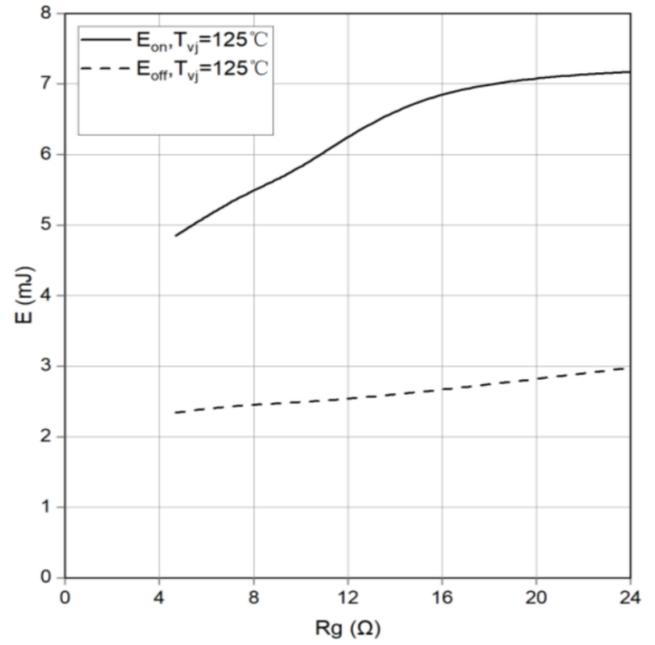


Fig. 6 Typical Switching Time vs. R_g at
T_C=25°C, V_{CE}=600V, V_{GE}=15V, I_C=40A

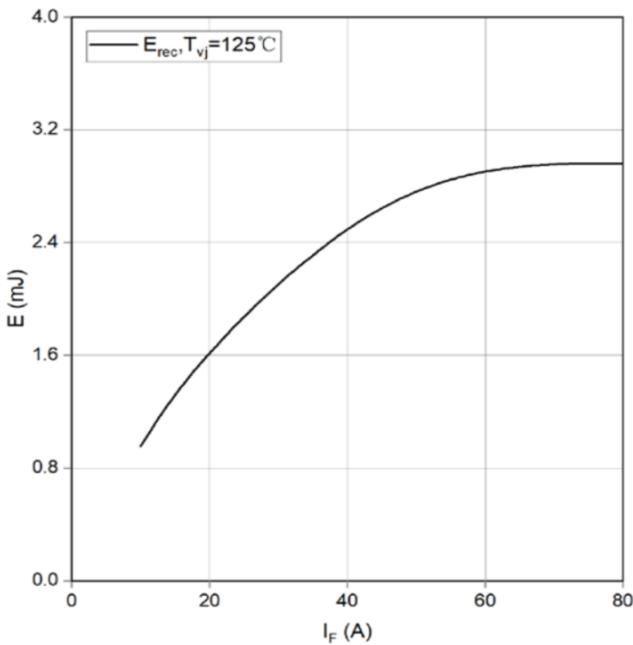


Fig. 7 Typical Diode Energy Loss vs. Ic at V_{CC}=600V
and R_g=4.7Ω

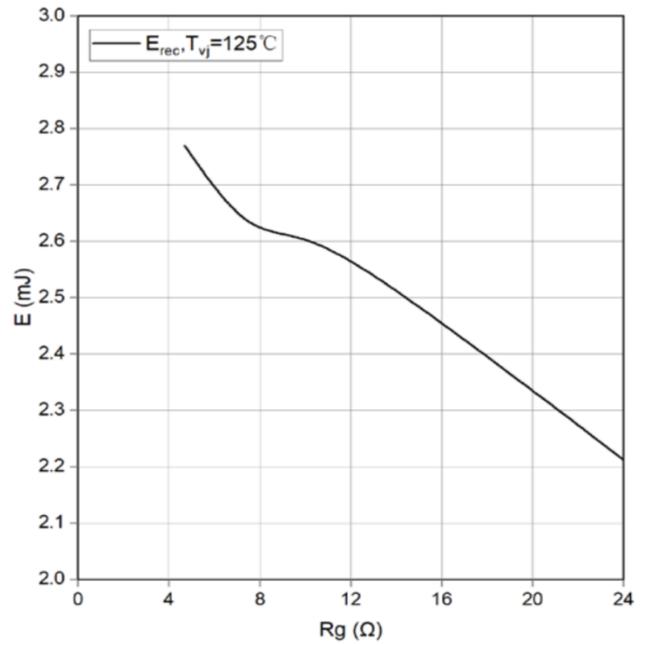
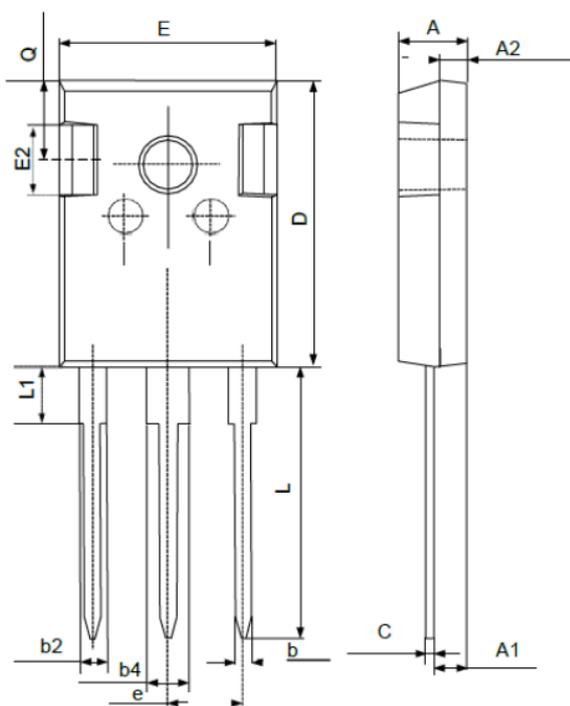


Fig. 8 Typical Diode Energy Loss vs. R_g at
V_{CC}=600V and I_F=40A

Package Information

TO-247



SYMBOL	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.59
A2	1.85	2.00	2.15
b	1.11	----	1.36
b2	1.91	----	2.25
b4	2.91	----	3.25
c	0.51	----	0.75
D	20.80	21.00	21.30
E	15.50	15.80	16.10
E2	4.40	5.00	5.20
e	5.44 BSC		
L	19.72	19.92	20.22
L1	----	----	4.30
Q	5.60	5.80	6.00